In a Nutshell

The FOR²ENSICS project aims to develop disruptive UHV SiC materials and devices, enabling more compact, efficient, and reliable power electronics with reduced losses and carbon emissions.

Unlike current industry roadmaps, FOR²ENSICS targets bipolar SiC devices above 10kV, opening new possibilities for grid applications. The project will also develop a next-generation DC solid-state transformer (SST) to demonstrate the advantages of these UHV SiC devices in real-world power conversion.

By advancing SiC materials, fabrication, and device design, FOR²ENSICS paves the way for industrialization and supports the future needs of high-voltage DC power systems.

Project objectives

Pillar 1

- 1. Develop 15 kV SiC IGBT Module for MVDC applications
- 2. Develop a waffer splitting technology that can reuse SiC wafers up to 10 times

Pillar 2

- Define an efficient test methodology related to UVH semiconductor devices
- 2. Demonstrate the reliability of SiC IGBT devices and passive components used in the demonstrator

Pillar 3

- Develop a DC/DC converter (SST) for interface between MVDC and LVDC based on a Dual Active Bridge
- 2. Identify at least 3 use cases for early adoption of the High Voltage SiC technology and DC SST

Who we are



CSIC IMB-CNM

www.imb-cnm.csic.es

Spain



Coherent

www.coherent.com

Sweeden



University of Cambridge www.cam.ac.uk

United Kingdom



Hitachi Energy

www.hitachienergy.com

Switzerland



Deep Concept www.deepconcept.fr

France



University of Bremen www.uni-bremen.de

Germany



Ecole polytechnique fédérale de Lausanne

www.epfl.ch

Switzerland



SuperGrid Institute

www.supergrid-institute.com

France

This project has received funding from the European Union's Horizon Europe research and innovation programme under grant agreement No 101075672.





FOR2ENSICS

Ultra high voltage SiC Solutions for MVDC Solid State Transformers

Expected results

Improved proces for Ultra High Voltage SiC bipolar devices manufacturing with high yield

Splitting proces for reuse of SiC Wafer up to 10 times

Development and manufacturing of 15 kV SiC IGBTs

Development and manufacturing a 15 kV power module based on the 15 kV IGBT

Increased reliability of 15 kV SiC IGTBs and 3.3 kV SiC MOSFETs

Development and manufacturing 10 kV - 10 kHz - 250 kW Medium Frequency transformer

Development and manufacturing 10 kV - 250 kW Inverter based on series connected 3.3 kV SiC MOSFETs

Development and manufacturing of a 1.5 kV to 10 kV 250 kW DC/DC Solid State Transformer for MVDC applications

Project Identity

Project Title:

Future Oriented Renewable and Reliable Energy SIC Solutions

Grant Agreement N°: 101075672

Start date: 1st January 2023

Duration: 48 months

Budget: 8,121,120.00 €

Find out more

Website: www.for2ensics.imb-cnm.csic.es







